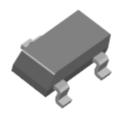
Analog Power AM2327P

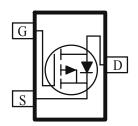
#### P-Channel 20-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize High Cell Density process. Low  $r_{DS(on)}$  assures minimal power loss and conserves energy, making this device ideal for use in power management circuitry. Typical applications are DC-DC converters, power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

- Low r<sub>DS(on)</sub> Provides Higher Efficiency and Extends Battery Life
- Miniature SOT-23 Surface Mount Package Saves Board Space
- Fast switching speed
- High performance trench technology

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$r_{DS(on)}$ (OHM)	$I_{D}(A)$		
	$0.052 @ V_{GS} = -4.5V$	-3.6		
-20	$0.072 @ V_{GS} = -2.5V$	-3.1		
	$0.120 @ V_{GS} = -1.8V$	-2.7		





ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C UNLESS OTHERWISE NOTED)					
Parameter		Symbol	Ratings	Units	
Drain-Source Voltage		$V_{DS}$	-20	V	
Gate-Source Voltage		$V_{GS}$	±8	V	
	$T_A=25^{\circ}C$	T	-3.6		
Continuous Drain Current <sup>a</sup>	$T_A=25^{\circ}C$ $T_A=70^{\circ}C$	$_{\mathrm{1D}}$	-1.8	A	
Pulsed Drain Current <sup>b</sup>		$I_{DM}$	-10		
Continuous Source Current (Diode Conduction) <sup>a</sup>		$I_S$	±0.46	A	
D	$T_A=25^{\circ}C$	D	1.25	W	
Power Dissipation <sup>a</sup>	$T_A=25^{\circ}C$ $T_A=70^{\circ}C$	PD	0.8	VV	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Maximum	Units			
Manimum Investiga to Ambient <sup>a</sup>	$t \le 5 \sec$	D	100	°C/W		
Maximum Junction-to-Ambient <sup>a</sup>	Steady-State	R <sub>THJA</sub>	150	] C/W		

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#### Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

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SPECIFICATIONS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)						
D	G 1.1	TD 4 C 194	Limits			T
Parameter	Symbol	Symbol Test Conditions		Тур	Max	Unit
Static						
Gate-Threshold Voltage	VGS(th)	$V_{DS} = V_{GS}$ , $I_D = -250 \text{ uA}$	-0.7			
Gate-Body Leakage	Igss	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			±100	nA
Z C VIII D C V	Ţ	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$			-1	uA
Zero Gate Voltage Drain Current	Idss	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			-10	
On-State Drain Current <sup>A</sup>	I <sub>D(on)</sub>	$V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-10			Α
		$V_{GS} = -4.5 \text{ V}, I_D = -3.6 \text{ A}$			52	
Drain-Source On-Resistance <sup>A</sup>	fDS(on)	$V_{GS} = -2.5 \text{ V}, I_D = -3.1 \text{ A}$			72	mΩ
		$V_{GS} = -1.8 \text{ V}, I_{D} = -2.7 \text{ A}$			120	
Forward Tranconductance <sup>A</sup>	gs	$V_{DS} = -5 \text{ V}, I_D = -1.25 \text{ A}$		12		S
Diode Forward Voltage	V <sub>SD</sub>	$I_S = -0.46 \text{ A}, V_{GS} = 0 \text{ V}$		-0.60		V
Dynamic <sup>b</sup>					•	-
Total Gate Charge	Qg	$V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V},$ $I_{D} = -2.4 \text{ A}$		12.0		nC
Gate-Source Charge	Qgs			2.0		
Gate-Drain Charge	Qgd			2.0		1
Input Capacitance	Ciss			1312		
Output Capacitance	Coss	P-Channel V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, f=1MHz		130		pF
Reverse Transfer Capacitance	Crss			106		
Turn-On Delay Time	td(on)			6.5		
Rise Time	tr	$V_{DD} = -10 \text{ V}, \text{ IL} = -1 \text{ A},$ $V_{GEN} = -4.5 \text{ V}, \text{ Rg} = 6 \Omega$		20		ns
Turn-Off Delay Time	t <sub>d(off)</sub>			31		
Fall-Time	tf			21		

#### Notes

- a. Pulse test:  $PW \le 300us duty cycle \le 2\%$ .
- b. Guaranteed by design, not subject to production testing.

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### Typical Electrical Characteristics

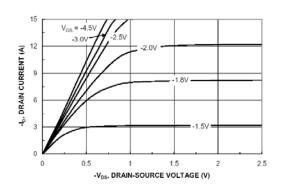


Figure 1. On-Region Characteristics

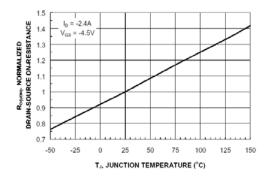


Figure 3. On-Resistance Variation with Temperature

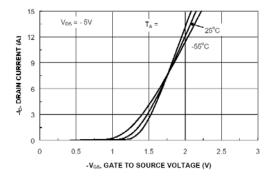


Figure 5. Transfer Characteristics

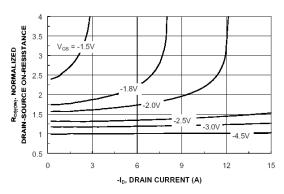


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage

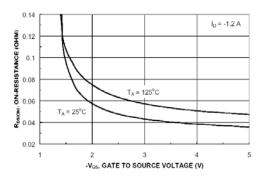


Figure 4. On-Resistance Variation with Gate to Source Voltage

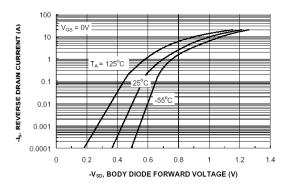
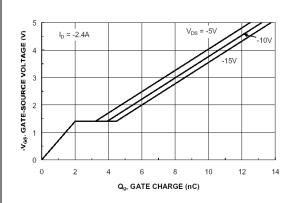


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

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## Typical Electrical Characteristics



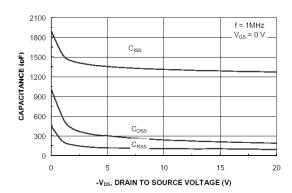


Figure 7. Gate Charge Characteristic

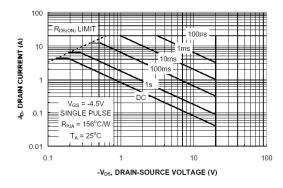


Figure 8. Capacitance Characteristic

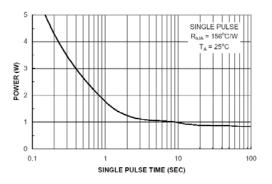


Figure 9. Maximum Safe Operating Area

Figure 10. Single Pulse Maximum Power
Dissipation



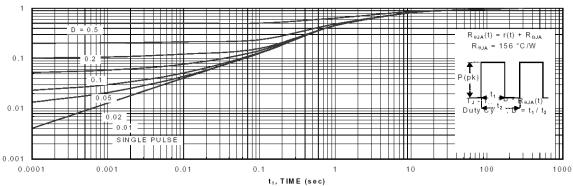
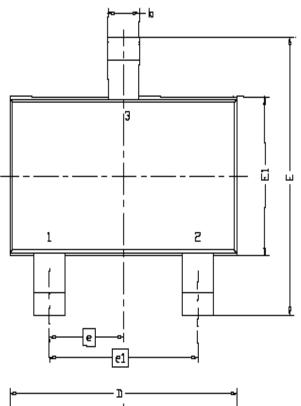
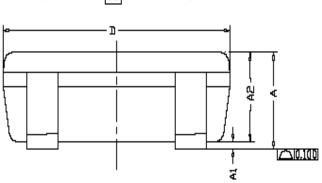


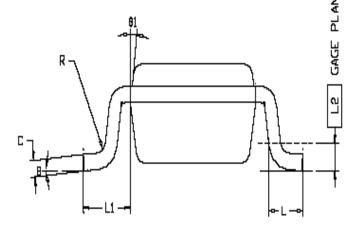
Figure 11. Transient Thermal Response Curve.

# Package Information



DIM.	MILLIMETERS			
יויודת	MIN	NDM	MAX	
Α	0.935	0.95	1.10	
A1	0.01	-	0.10	
A2	0.85	0.90	0.925	
р	0.30	0.40	0.50	
u	0.10	0.15	0.25	
D	2.70	2.90	3.10	
П	2.60	2.80	3.00	
E1	1.40	1.60	1.80	
6	0.95 BSC			
el	1.90 BSC			
Г	0.30	0.40	0.60	
L1	0.60REF			
LZ	0.25BSC			
R	0.10			
θ	Q+	4*	8,	
81	7"N□M			





## Ordering information

• AM2327P-T1-XX

- A: Analog Power

- M: MOSFET

- 2327: Part number

- P: P-Channel

- T1: Tape & reel

- XX: Blank: Standard

PF: Leadfree

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